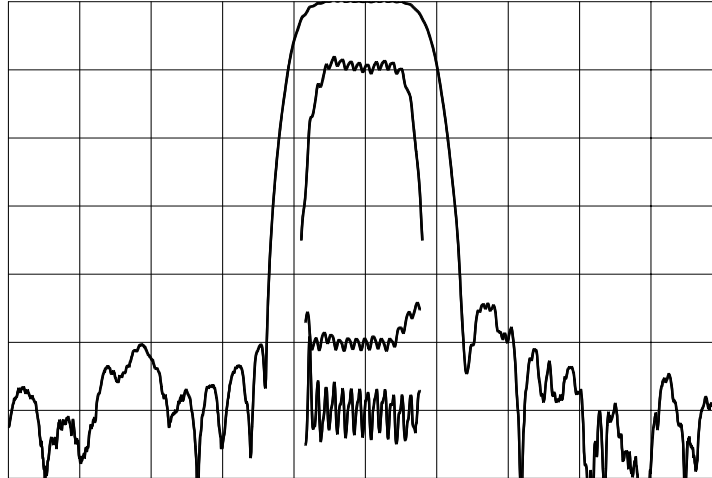


TYPICAL PERFORMANCE



Horizontal: 4 MHz/div

Vertical (from top):

Magnitude

10, 1 dB/div

Phase

5 deg/div

Group Delay

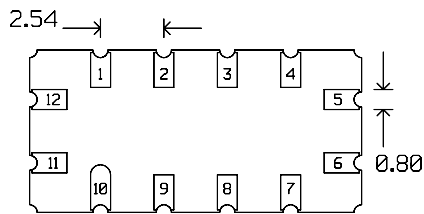
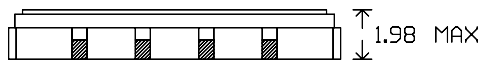
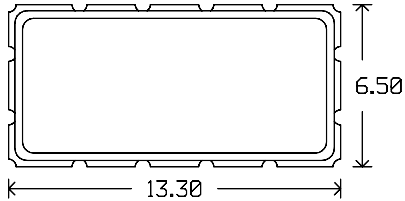
50 ns/div

SPECIFICATION

Parameter	Min	Typ	Max	Units
Center Frequency, F_c (fixed reference)		77.8		MHz
Operating Bandwidth		3.84		MHz
Insertion Loss at F_c		12	15	dB
Amplitude Ripple ¹		0.3	1	dB
Triple travel suppression	35	42		dB
Lower 35 dB Frequency	71.5	72.5		MHz
Upper 35 dB Frequency		83.0	84.1	MHz
Phase Linearity ¹		2	8	deg
Group Delay Variation ¹		45	100	ns
Absolute Delay		1.06	1.5	μ s
Rejection ²				dB
0.3~7 MHz	25	44		dB
7~63 MHz	45	55		dB
63~71.5 MHz	35	50		dB
84.1~87.8 MHz	32	42		dB
87.8~93 MHz	40	53		dB
93~140 MHz	45	57		dB
140~170 MHz	25	31		dB
170~300 MHz	45	60		dB
Input and Output Return Loss ^{1,5}	10			dB
Operating Input Power			-10	dBm
Maximum Input Power Without Damage	17			dBm
Operating Temperature Range ⁴	-10		+85	$^{\circ}$ C
Storage Temperature Range	-40		+95	$^{\circ}$ C
System Source and Load Impedance		50		Ω

- Notes:
1. Applies over the operating bandwidth
 2. Rejection relative to passband insertion loss
 3. Measured with tones spaced at 10 and 20 MHz above and below F_c
 4. All parameters to be met over the operating temperature range, except return loss
 5. Room temperature only.

PACKAGE OUTLINE

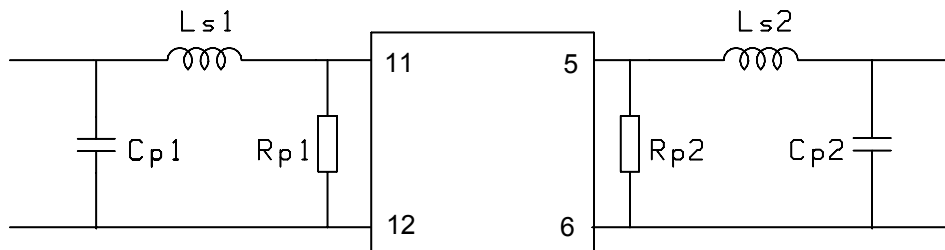


Units: mm

Pin Configuration:

Input: 11
Input Return: 12
Output: 5
Output Return: 6
Ground: 1,2,3,4,7,8,9,10

MATCHING CIRCUIT



Component values in 50 Ω :
(Minimum Q = 45)

Rp1 = 220 Ω
Ls1 = 120 nH
Cp1 = 47 pF

Rp2 = 220 Ω
Ls2 = 150 nH
Cp2 = 33 pF

Notes

- Optimum component values may change depending on board layout. The values shown here are intended as a guide only.